

Remarks:

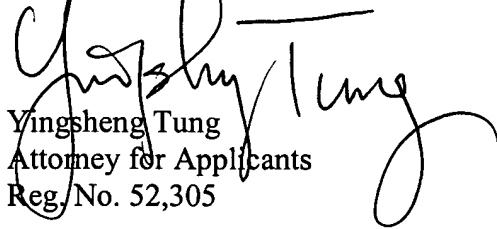
Applicants thank Examiner Perez-Daple again for his patient and careful examination of this application and clear explanation of the objections and rejections. In response, applicants amend claims 28 and 29 to overcome the deficiencies:

1. Applicants amend claims 28 and 29 to remove the limitation of plurality of bonders and thus overcome the objection to the drawings in section 4 of the Office Action.
2. The amendments in 1 also overcome the objection to the Specification in Section 5 of the Office Action.
3. The amendments in 1 also overcome the 112 rejection to claims 28 and 29 in Section 7 of the Office Action.
4. The amendment to claim 28 removes the indefiniteness objected in Section 9 of the Office Action. Claim 29 does not have the same objected term.
5. The amended claims 28 and 29 also overcome the 103 rejection because the Kono patent does not teach communication between two bonders relating to a device program including information related to the semiconductor chip and the segments, the reference members, the coordinates of the reference members, and the visual representations and a second bonder generating a corrected device program related to the semiconductor chip and the segments, the reference members, the coordinates of the reference members, and the visual representations. Because the Kono patent does not disclose all the elements of claims 28 and 29 and it does not suggest or teach the combinations of claims 28 and 29, it does not render claims 28 and 29 obvious.

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Applicants respectfully submit that as amended, this application is in allowable form;
amended claims 27 and 28 distinguish from the cited reference and are patentable.
Applicants respectfully request that the application be further examined and the claims
pass to allowance.

Respectfully submitted,


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